



PATENT

Atty. Docket No. 8055-83 CIP (In1292USD1)

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S): Gerald Friese Examiner: William A. Powell
SERIAL NO.: 09/893,160 Group Art Unit: 1765
FILED: June 27, 2001
FOR: POWER PADS FOR APPLICATION OF HIGH CURRENT
PER BOND PAD IN SILICON TECHNOLOGY

Dated: June 10, 2003

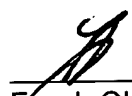
Mail Stop Issue Fee
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL OF FORMAL DRAWINGS

Sir:

Applicant submits herewith six (6) sheets of formal drawings
depicting FIGS. 1-7 for this application.

Respectfully submitted,



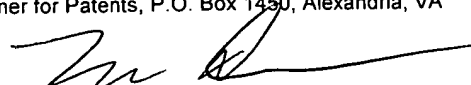
Frank Chau
Reg. No. 34,136
Attorney for Applicant(s)

F. CHAU & ASSOCIATES, LLP
1900 Hempstead Turnpike
Suite 501
East Meadow, New York 11554
(516) 357-0091

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

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Frank V. DeRosa

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FIG. 1

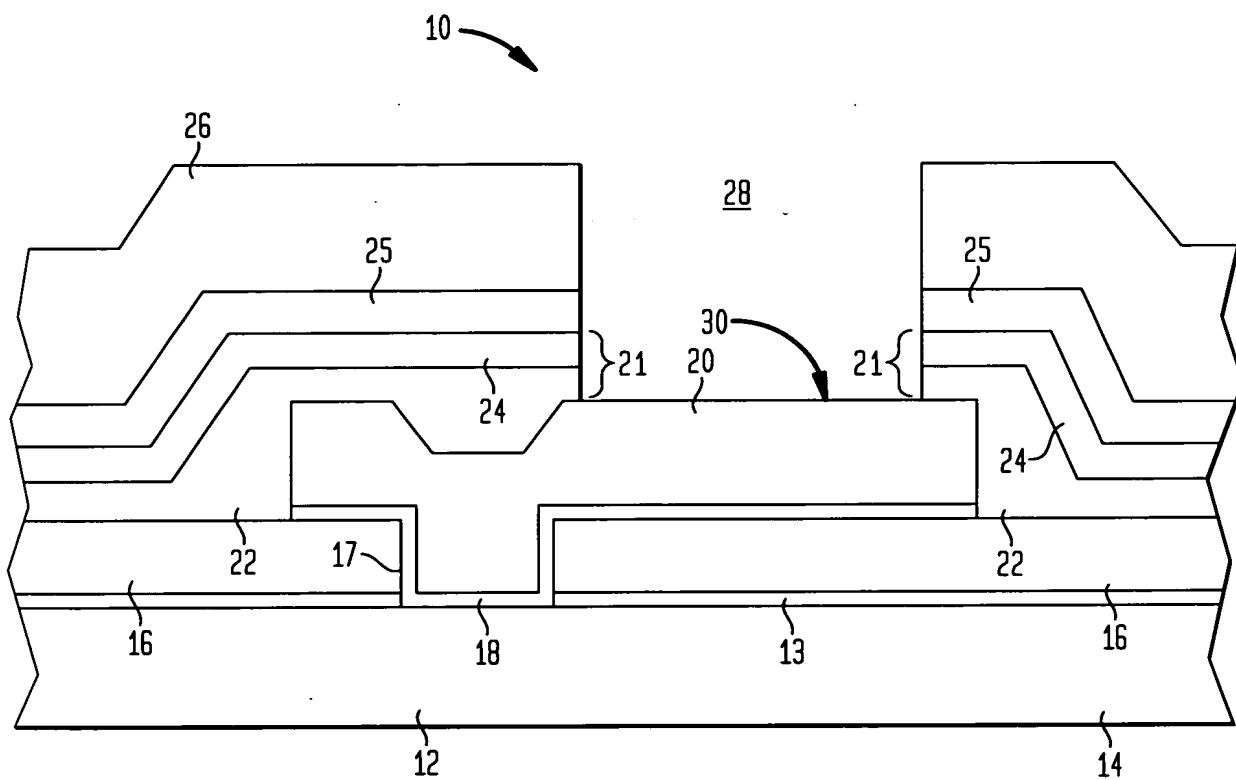
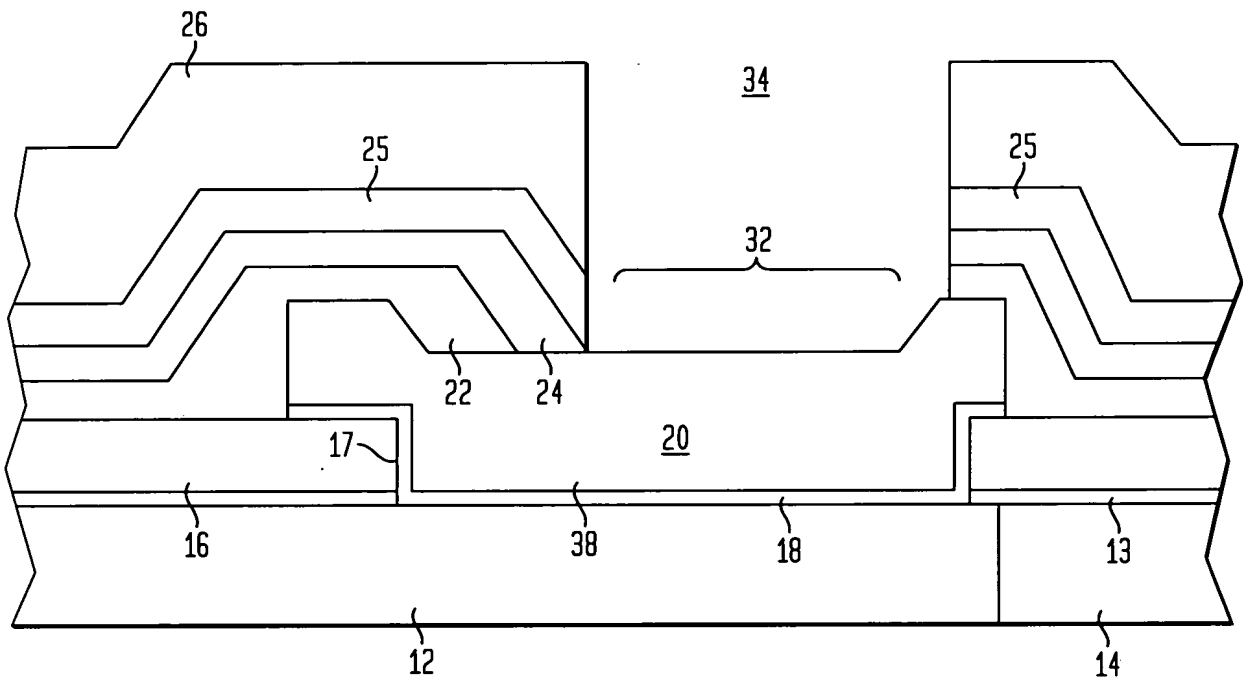


FIG. 2





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FIG. 3

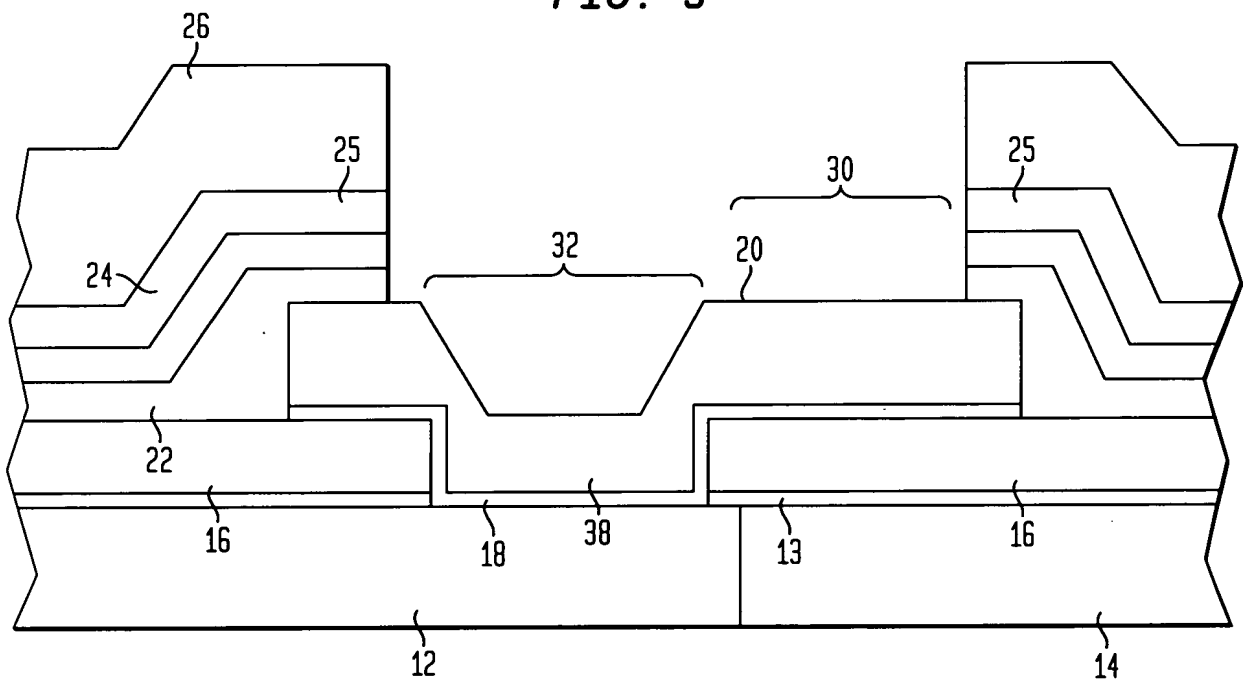


FIG. 4

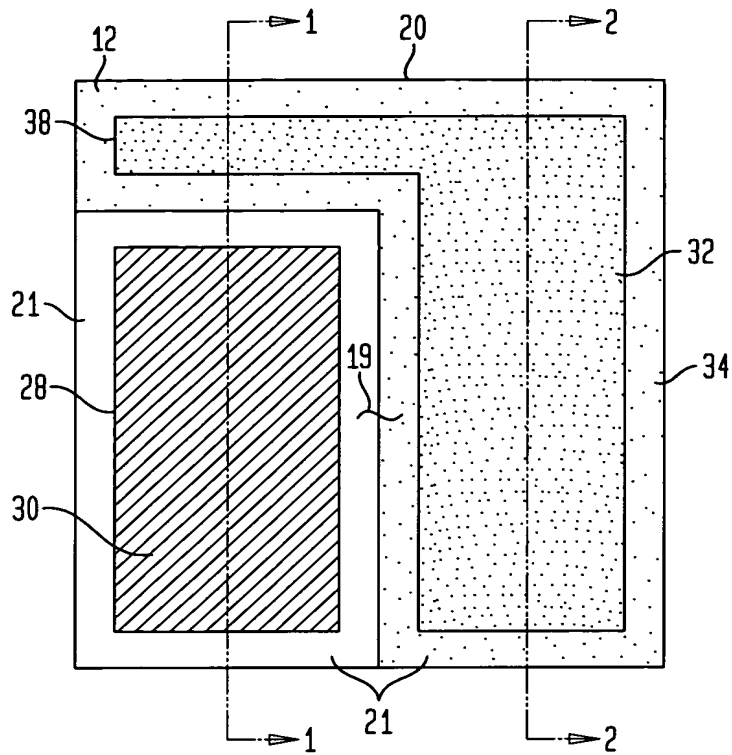


FIG. 5

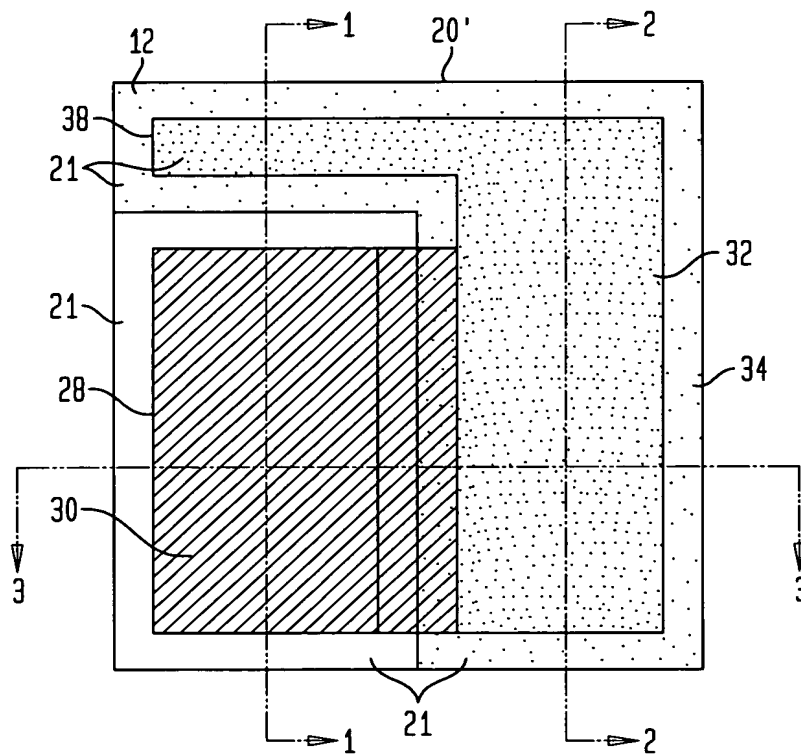


FIG. 6

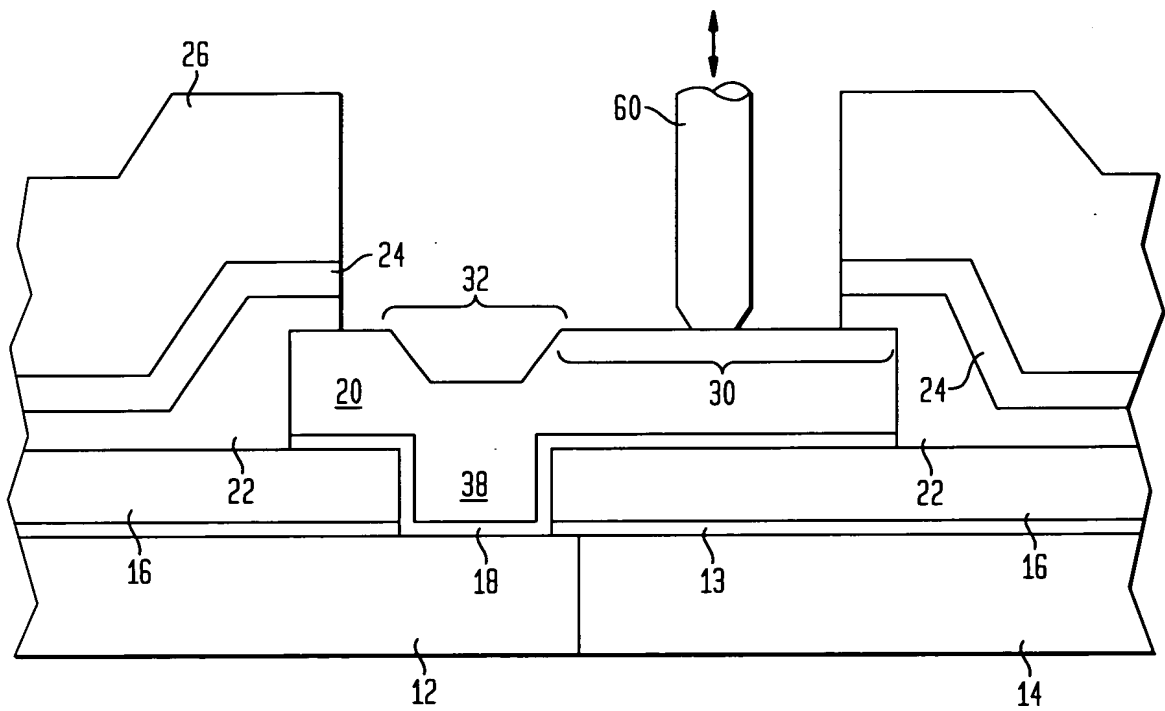


FIG. 7

